

1752-2 1.1

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Declaration Class* Matarials and Mfa

^{Form Type*}	Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg
Distribute	Infomation

	Infollation							
Supplier Information								
Company Name *	Company Unique ID	Unique ID Authority	Response Date*					
Fairchild Semiconductor	00-489-5751	Dun & Bradstreet	Sat, Aug 09, 2014 03:19 AM					
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *					
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Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *					
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					

Requester Item Number	iber Mfr Item Number		Mfr Item Name		Effective Date	Version	P	Manufacturing Site	Weight*	UOM	Unit Type
FXLP34P5X	FXL	P34P5X	SC70-5 (C194LF)	(G)			INT	ERNAL CEBU	0.005832	g	Each
Manufacturing Process Information											
Terminal Finish	Base Alloy	J-STD-0	0 MSL Rating Peak		Peak Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles		
Matte Tin (Sn)	CU Alloy		1	260 C		30 seconds			3		

* Required Field

 RoHS Material Composition Declaration
 Declaration Type * Custom

 RoHS Directive 2011/65/EU
 RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE)

This document is Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this document is based upon information collected from Fairchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.

The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.

Note: The substance content disclosed herewith is approximate and is based on various methods including, engineering calculations, supplier surveys, Material Safety Data Sheets, analytical measurements. Fairchild may update this document without notification. This statement may not include information regarding the miniscule quantities of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed for Resin substances are generic and may contain alternate substances of similar composition.

RoHS Declaration * 1 - Item

1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. Exemption List Version EL-2011/534/EU

Declaration Signature

and Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name SC70-5 (C194LF) (G)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	0.147	Supplier		Silicon	0.147	7440-21-3	25204
Die Attach	Other Organic Materials	0.037	Supplier		Phenolic resin	0.008	54208-63-8	1375
			Supplier		Silver	0.029	7440-22-4	5024
Encapsulation	Thermoplastics	3.182	Supplier		Carbon Black	0.032	1333-86-4	5455
			Supplier		Epoxy Resin	0.636	29690-82-2	109103
			Supplier		Silica, vitreous	2.514	60676-86-0	430957
Lead Frame	Copper & its alloys	2.213	Supplier		Copper	2.140	7440-50-8	366911
			Supplier		Iron	0.053	7439-89-6	9087
			Supplier		Phosphorus	0.001	7723-14-0	152
			Supplier		Silver	0.016	7440-22-4	2726
			Supplier		Zinc	0.003	7440-66-6	492
Plating	Other Nonferrous metals & alloys	0.228	Supplier		Tin	0.228	7440-31-5	39091
Wire Bond	Precious metals	0.026	Supplier		Gold	0.026	7440-57-5	4424